

DOCKET NO: 259189US53PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
MOTOO ASAI, ET AL. : EXAMINER: JAHAN, BILKIS
SERIAL NO: 10/509,899 :
FILED: JUNE 29, 2005 : GROUP ART UNIT: 2814
FOR: SUBSTRATE FOR MOUNTING IC :
CHIP, MANUFACTURING METHOD OF
SUBSTRATE FOR MOUNTING IC CHIP,
DEVICE FOR OPTICAL
COMMUNICATION, AND
MANUFACTURING METHOD OF
DEVICE FOR OPTICAL
COMMUNICATION

AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated April 27, 2010, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 15 of this paper.